



### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

V <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
30V	6.5mΩ @ V <sub>GS</sub> = 10V	46.2A
	10mΩ @ V <sub>GS</sub> = 4.5V	37.0A

## **Description**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

## **Applications**

- Backlighting
- Power Management Functions
- DC-DC Converters

V-DFN3030-8 (Type Q)

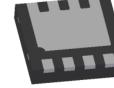
### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

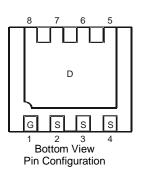
### **Mechanical Data**

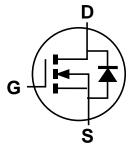
- Case: V-DFN3030-8 (Type Q)
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0172 grams (Approximate)





Bottom View





**Equivalent Circuit** 

## **Ordering Information** (Note 4)

Top View

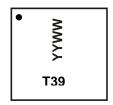
Part Number	Case	Packaging
DMT3006LDK-7	V-DFN3030-8 (Type Q)	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# Marking Information

V-DFN3030-8 (Type Q)



T39 = Product Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 for 2017) WW = Week Code (01 to 53)

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# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current V <sub>GS</sub> = 10V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C (Note 6)	I <sub>D</sub>	17.1 13.7	А
	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	I <sub>D</sub>	46.2 37.0	А
Maximum Continuous Body Diode Forward Current (	Note 6)	Is	2	А
Pulsed Drain Current (10µS Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	80	А
Avalanche Current (Note 7) L = 0.1mH		I <sub>AS</sub>	25	Α
Avalanche Energy (Note 7) L = 0.1mH		Eas	31	mJ

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		$P_D$	1.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	116	°C/W
Total Power Dissipation (Note 6)		P <sub>D</sub>	2.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	44	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	6	C/VV	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	1 - 7		- 71-				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = +20V, V_{DS} = 0V$ $V_{GS} = -16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						•	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	_	3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	Rds(on)	_	5.5	6.5	mΩ	$V_{GS} = 10V, I_D = 12A$	
Static Drain-Source On-Nesistance	KDS(ON)	_	7.5	10	11122	$V_{GS} = 4.5V, I_D = 12A$	
Diode Forward Voltage	$V_{SD}$	_	_	1.0	V	$V_{GS} = 0V, I_{S} = 2A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	1,155	_		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	456	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	72	_			
Gate Resistance	Rg	_	1.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	16.7	_		V <sub>DD</sub> = 15V, I <sub>D</sub> = 9A	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_{g}$	_	8.4	_	nC		
Gate-Source Charge	Q <sub>gs</sub>	_	2.2	_	IIC		
Gate-Drain Charge	$Q_{gd}$	_	3.5	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.5	_		$V_{DD}$ = 15V, $V_{GS}$ = 10V, $R_g$ = 3 $\Omega$ , $I_D$ = 9A	
Turn-On Rise Time	t <sub>R</sub>	_	5.5	_	no		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	13.5	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	4.6	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	19.3	_	ns	1 1 5 A di/dt 100 \( \frac{1}{2} \)	
Body Diode Reverse Recovery Charge	$Q_{RR}$	_	8.6	_	nC	$I_F = 1.5A$ , di/dt = 100A/ $\mu$ s	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

<sup>6.</sup> Device mounted on 4.75 inches by 4.5 inches FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

<sup>7.</sup>  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

<sup>8.</sup> Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.



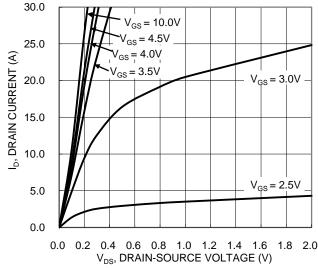


Figure 1. Typical Output Characteristic

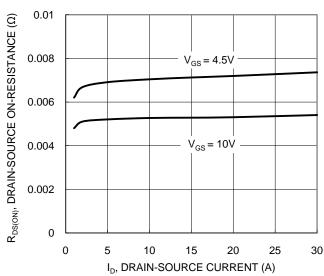


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

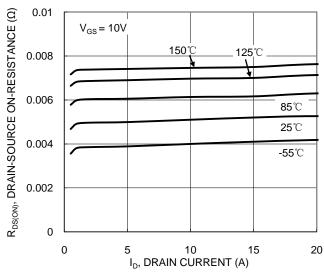


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

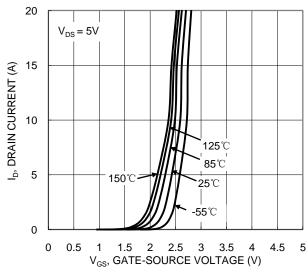


Figure 2. Typical Transfer Characteristic

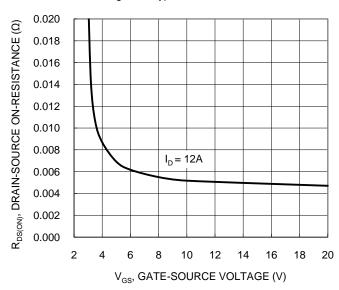
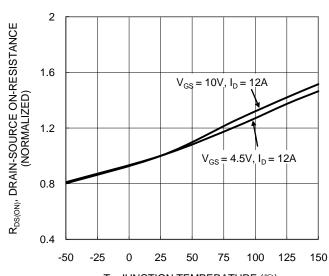


Figure 4. Typical Transfer Characteristic







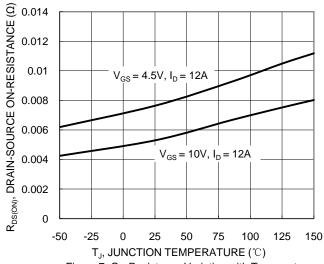
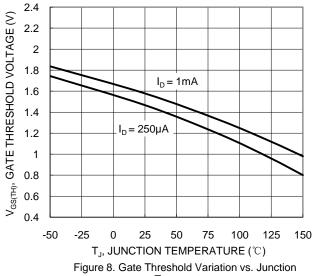
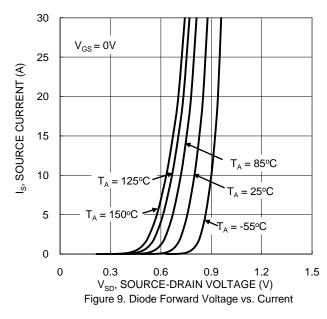
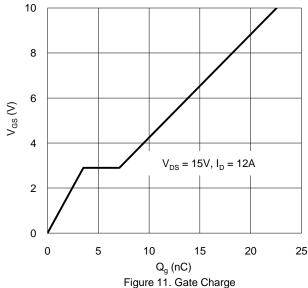


Figure 7. On-Resistance Variation with Temperature

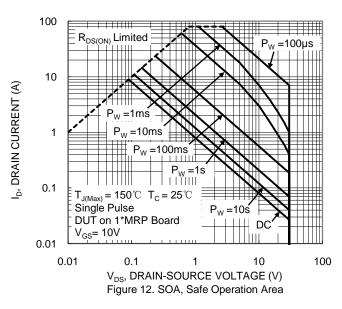


Temperature





10000 f=1MHz  $C_{\text{iss}}$ C<sub>T</sub>, JUNCTION CAPACITANCE (pF) 1000 Coss 100  $C_{rss}$ 10 1 0 10 15 20 25 30 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 10. Typical Junction Capacitance





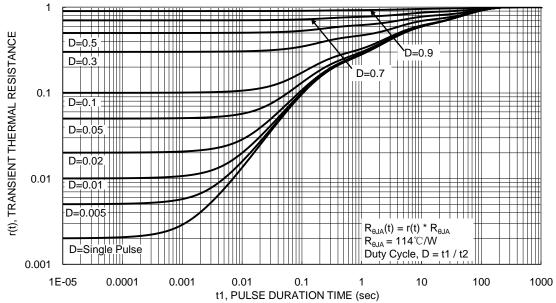


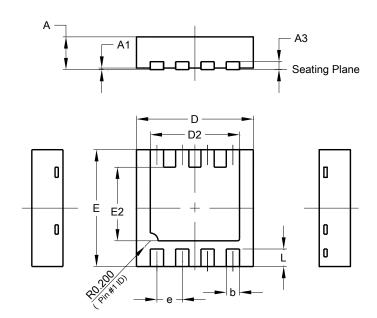
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### V-DFN3030-8 (Type Q)

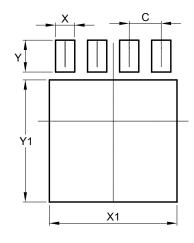


V-DFN3030-8 (Type Q)				
Dim	Min	Max	Тур	
Α	0.77	0.83	0.80	
A1	0.00	0.05	0.02	
А3			0.203	
b	0.29	0.39	0.34	
D	2.95	3.05	3.00	
D2	2.19	2.39	2.29	
Е	2.95	3.05	3.00	
E2	1.64	1.84	1.74	
е		1	0.65	
L	0.40	0.50	0.45	
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### V-DFN3030-8 (Type Q)



Dimensions	Value (in mm)		
С	0.650		
Х	0.390		
X1	2.590		
Y	0.650		
Y1	2.490		



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